# **Specification of Thermoelectric Module**

## **TES1-19970**

### Description

The 199 couples, 30 mm  $\times$  30 mm size module which is made of selected high performance ingot to achieve superior cooling performance and greater delta T up to 70 °C, designed for superior cooling and heating up to 100 °C applications. If higher operation or processing temperature is required, please specify, we can design and manufacture the custom made module according to your special requirements.

### Features

- No moving parts, no noise, and solid-state
- Compact structure, small in size, light in weight
- Environmental friendly
- RoHS compliant
- Precise temperature control
- Exceptionally reliable in quality, high performance

### Performance Specification Sheet

### Application

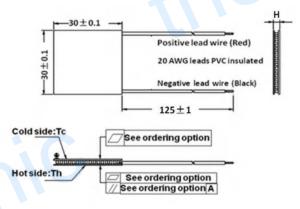
- Food and beverage service refrigerator
- Portable cooler box for cars
- Liquid cooling

2. Aluminum Nitride (AlN)

- Temperature stabilizer
- CPU cooler and scientific instrument
- Photonic and medical systems

errormance specification sheet					
Th (°C)	27	50	Hot side temperature at environment: dry air, N <sub>2</sub>		
DT <sub>max</sub> (°C)	70	79	Temperature Difference between cold and hot side of the		
			module when cooling capacity is zero at cold side		
U <sub>max</sub> (Voltage)	25.6	27.4	Voltage applied to the module at DT <sub>max</sub>		
I <sub>max</sub> (amps)	7.0	7.0	DC current through the modules at DT <sub>max</sub>		
Q <sub>Cmax</sub> (Watts)	112.2	122.9	Cooling capacity at cold side of the module under $DT = 0$ °C		
AC resistance (Ohms)	2.72	2.93	The module resistance is tested under AC		
Tolerance (%)	± 10		For thermal and electricity parameters		

### Geometric Characteristics Dimensions in millimeters



# A. Solder:B. Sealant:1. T100: BiSn (Tmelt=138°C)1. NS: No sealing (Standard)2. T200: CuAgSn (Tmelt = 217°C)2. SS: Silicone sealant3. T240: SbSn (Tmelt = 240°C)3. EPS: Epoxy sealantC. Ceramics:D. Ceramics Surface Options:1. Alumina (Al<sub>2</sub>O<sub>3</sub>, white 96%)1. Blank ceramics (not metalized)

**Ordering Option** 



2. Metalized

				TES1-19970- X-X-X-X	
Suffix Thickness		Flatness/	Lead wire length(mm)	ТТТТ	
Sum	(mm)	Parallelism (mm)	Standard/Optional length Ceramics   125 ± 1/Specify Sealant		
TF	$0:2.8 \pm 0.1$	0:0.07/0.07			
TF	$1:2.8 \pm 0.03$	1:0.025/0.025 $125 \pm 1/$ Specify		TES1- 19970–T100 -NS –TF01 -AIO	
Eg. TF01: Thickness $2.8 \pm 0.1$ (mm) and Flatness $0.025 / 0.025$ (mm)				T100: BiSn(Tmelt=138°C) NS: No sealing AlO: Alumina. white 96%	

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Imax = 7 AI = 6 A

I = 5 A

I = 4 A

I = 3 A

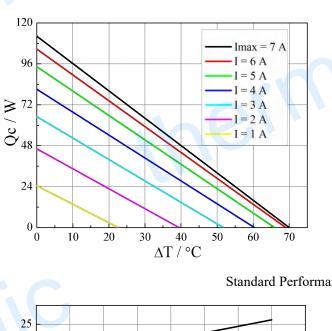
I = 2 A

I = 1 A

60

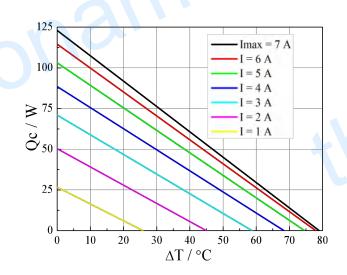
70

8(



Performance Curves at Th=27 °C

**Performance Curves at Th=50 °C** 



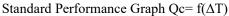
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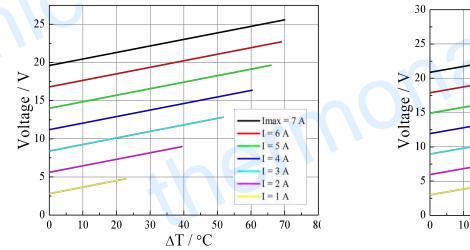
40

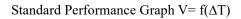
 $\Delta T / °C$ 

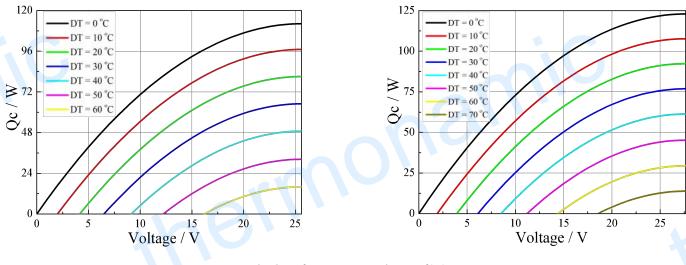
50

20





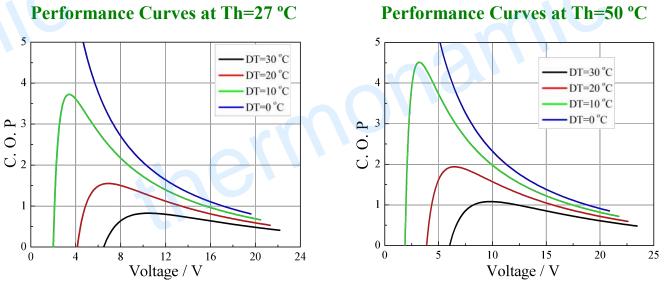




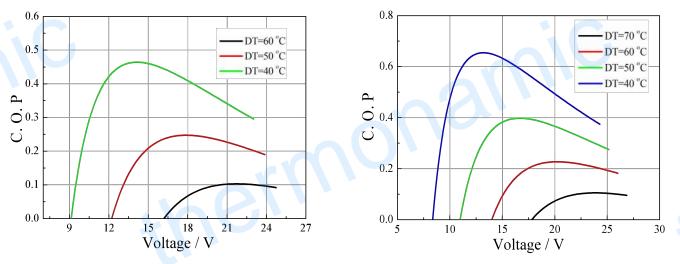
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Standard Performance Graph COP = f(V) of  $\Delta T$  ranged from 0 to 30 °C



Standard Performance Graph COP = f(V) of  $\Delta T$  ranged from 40 to 60/70 °C

Remark: The coefficient of performance (COP) is the cooling power Qc/Input power (V × I).

### **Operation Cautions**

- Attach the cold side of module to the object to be cooled
- menc • Attach the hot side of module to a heat radiator for heat dissipating
- Storage module below 100 °C
- Operation below I<sub>max</sub> or V<sub>max</sub>
- Work under DC